DATA IMAGE CORPORATION

LCD Module Specification

ITEM NO.: **CM16022ASFAYBG02**

Table of Contents

Customer Companies	R&D Dept.	Q.C. Dept.	Eng. Dept.	Prod. Dept.
	JACK	ERIC	KEN	HELEN
Approved by	Version:	Issued Date:	Sheet Code:	Total Pages:
	A	2005/8/30		26

2. RECORD OF REVISION

Rev	Date	Item	Page	Comment
A	2005/8/30			New Release.

3. GENERAL SPECIFICATION

Display Format :	16characters (W)	×	2lines (H)	
Character Size :	2.95 (W)	×	5.55 (H)	mm
View Area :	62.2 (W)	×	17.9 (H)	mm
General Dimensions :	80 (W)	×	36 (H) × 14.5 (T)	mm Max.
Weight :	40 g max.			

LCD Type & Background Color: ☐ STN Gray ☑ STN Yellow Green ☐ FSTN

Polarizer mode : ☐ Reflective ☑ Transflective ☐ Transmissive ☐ Negative

View Angle : ☑ 6 O'clock ☐ 12 O'clock ☐ Others _____

Backlight : ☑ LED ☐ EL ☐ CCFL

Backlight Color : ☑ Yellow green ☐ Amber ☐ Blue Green ☐ White ☐ Others

Controller / Driver : NT3881DH-0T074

Temperature Range :

☐ Normal		☑ Wide Temperature	
Operating	0 to 50°C	Operating	-20 to 70°C
Storage	-20 to 70°C	Storage	-30 to 80°C

Remark : J2,J4,J6,J8 Short.

Pixel Color: Blue

REMARK:

Our components and processes are compliant to RoHS standard

4. ABSOLUTE MAXIMUM RATINGS

4.1 ELECTRICAL ABSOLUTE MAXIMUM RATINGS

V_{SS}= 0V, Ta = 25°C

Item	Symbol	Min.	Max.	Unit
Supply Voltage (Logic)	V_{DD}-V_{SS}	0	7	V
Supply Voltage (LCD Driver)	V_{DD} -V_O	-0.3	13.5	V
Input Voltage	V_I	V_{SS}	V_{DD}	V
Operating Temperature	T_{OP}	-20	70	℃
Storage Temperature	T_{STG}	-30	80	℃

4.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS

Item	Operating		Storage		Comment
	(Min.)	(Max.)	(Min.)	(Max.)	
Ambient Temp	-20	70	-30	80	Note (1)
Humidity	Note (2)		Note(2)		Without Condensation
Vibration	--	4.9M/S^2	--	19.6M/S^2	XYZ Direction
Shock	--	29.4M/S^2	--	490M/S^2	XYZ Direction

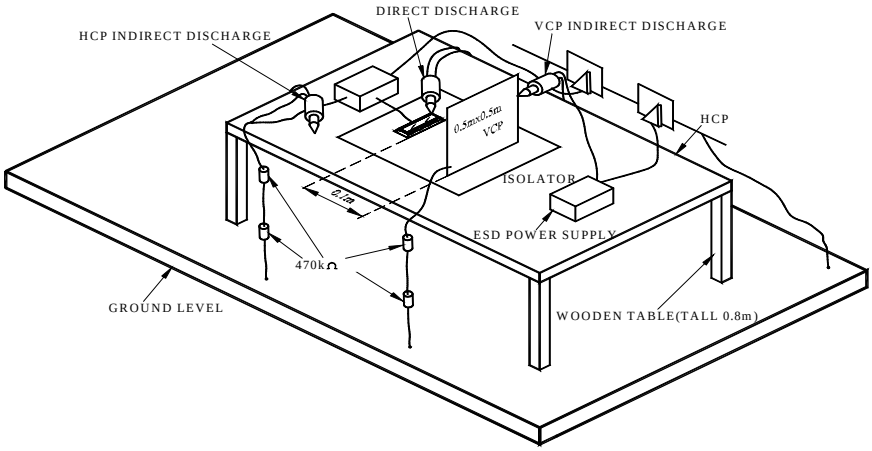
Note(1) Ta = 0°C : 50Hr Max.
Note(2) Ta ≤ 40°C : 90% RH Max.
Ta ≥ 40°C : Absolute humidity must be lower than the humidity of 90% at 40°C.

4.3 Electronic Static Discharge maximum rating

ESD test method : IEC1000-4-2

Item	Description	
Testing environment	Ambient temperature :15°C to 35 °C Humidity: 30% to 60 % LCM (E.U.T) : Power up	
Testing equipment	Manufacture: Noise Ken, Model No. ESD-100L	
Testing condition	See drawing 1	
Direct discharge	0 to ± 6 KV	Discharge point, see drawing 2
Indirect discharge	0 to ± 12KV	Discharge point, see drawing 1
Pass condition	No malfunction of unit. Temporary malfunction of unit which can be recovered by system reset	
Fail condition	Non. Recoverable malfunction of LCM or system	

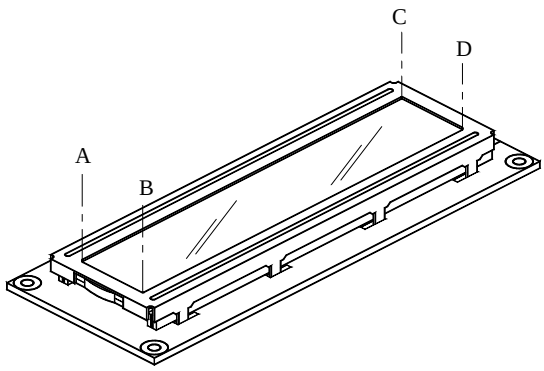
FIG 1 ESD TESTING EQUIPMENT



(1)

DIRECT CONTACT DISCHARGE

CONTACT POINT : A.B.C.D



(2)

5. ELECTRICAL CHARACTERISTICS

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Supply Voltage (Logic)	V_{DD}-V_{SS}		2.7	5.0	5.5	V
Supply Voltage (LCD)	V_{DD}-V_0	-20°C	4.0	4.3	4.7	V
		25°C	3.8	4.1	4.2	
		70°C	3.3	3.7	3.9	
Input Voltage	V_{IH}	V_{DD} =4.5~5.5	2.2	--	V_{DD}	V
	V_{IL}		-0.3	--	0.8	
Logic Supply Current	I_{DD}	V_{DD}-V_{SS}=5V	--	--	2.0	mA

6. ELECTRO-OPTICAL CHARACTERISTICS

ITEM	Symbol	Condition	Min.	Typ.	Max.	Unit	Ref.
Rise Time	Tr	-20°C	873	2640	8120	ms	Note (1)
		25°C	42	120	351		
Fall Time	Tf	-20°C	896	2820	8350	ms	
		25°C	59	150	420		
Contrast	CR	25°C	10	--	14		Note (3)
View Angle	θ1~θ2 ∅1, ∅2	25°C & CR≥3	55	--	65		Note (2)
			65	--	75		
Frame Frequency	Ff	25°C	--	64	--	Hz	

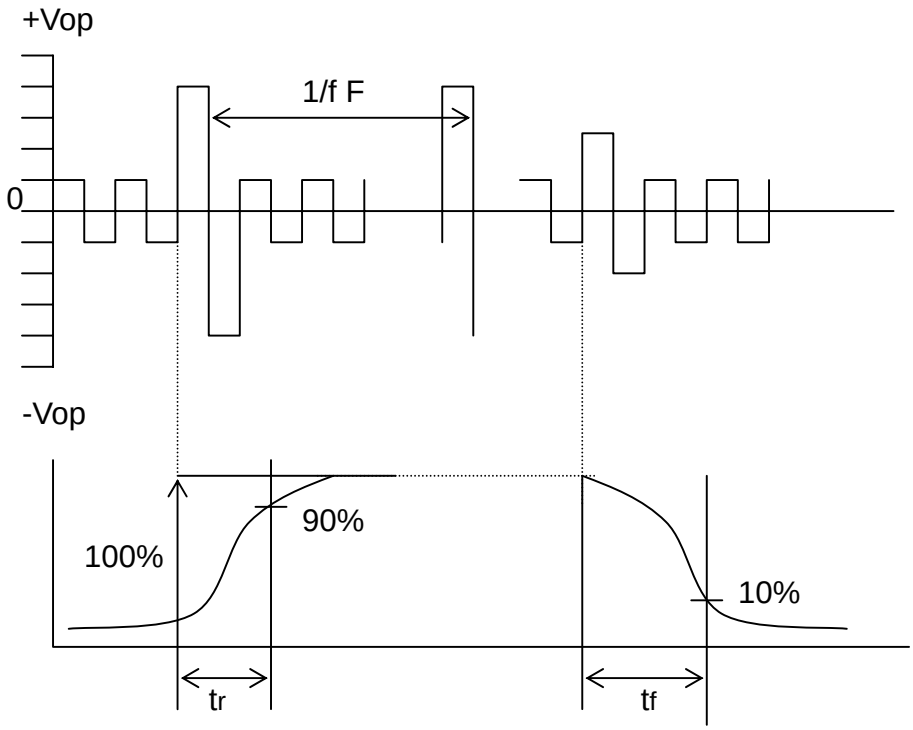
Note (1) & (2) : See next page

Note (3) : Contrast ration is defined under the following condition:

$$CR = \frac{\text{Brightness of non-selected condition}}{\text{Brightness of selected condition}}$$

(a). Temperature ---------- 25°C
(b). Frame frequency ---- 64Hz
(c). Viewing angle -------- θ= 0°, ∅ = 0°
(d). Operating voltage --- 4.1V

Note (1) Response time is measured as the shortest period of time possible between the change in state of an LCD segment as demonstrated below:

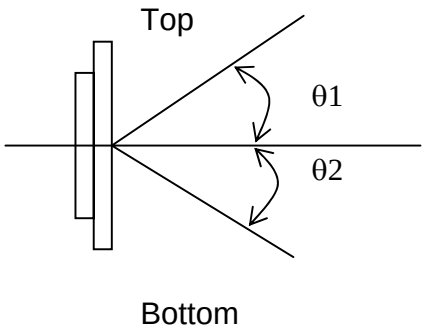


Condition:

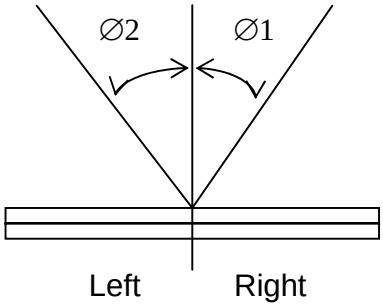
(a) . Temperature ----------25°C
(b) . Frame frequency --------- 64Hz
(c) . View Angle ---------- θ = 0°, ∅=0°
(d) . Operating voltage -------- 4.1V

Note (2) Definition of View Angle

Top – Bottom direction



Right -- Left direction



6.1 LED ELECTRO-OPTICAL CHARACTERISTIC

Ta = 25°C

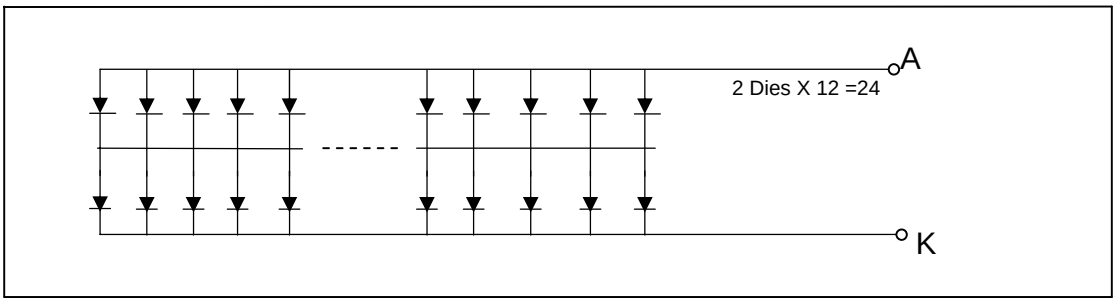
Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V_F	IF =120mA Yellow Green	--	4.1	4.2	V
Luminous Intensity	I_V	IF = 120mA Yellow Green	55	90	--	cd/m^2
Peak Emission	λP	IF = 120mA Yellow Green	--	573	--	nm
Spectrum Radiation	Δλ	IF = 120mA Yellow Green	--	30	--	nm
Reverse Current	IR	VR = 8V Yellow Green	--	--	0.2	mA

Note : Measured at the bared LED backlight unit.

6.2 LED MAXIMUM OPERATING RANGE

Item	Symbol	Yellow Green	Unit
Power Dissipation	P_{AD}	0.76	W
Forward Current	I_{AF}	180	mA
Reverse Voltage	VR	8	V

6.2.1 LED ARRAY BLOCK DIAGRAM



6.2.2 LED POWER SOURCE

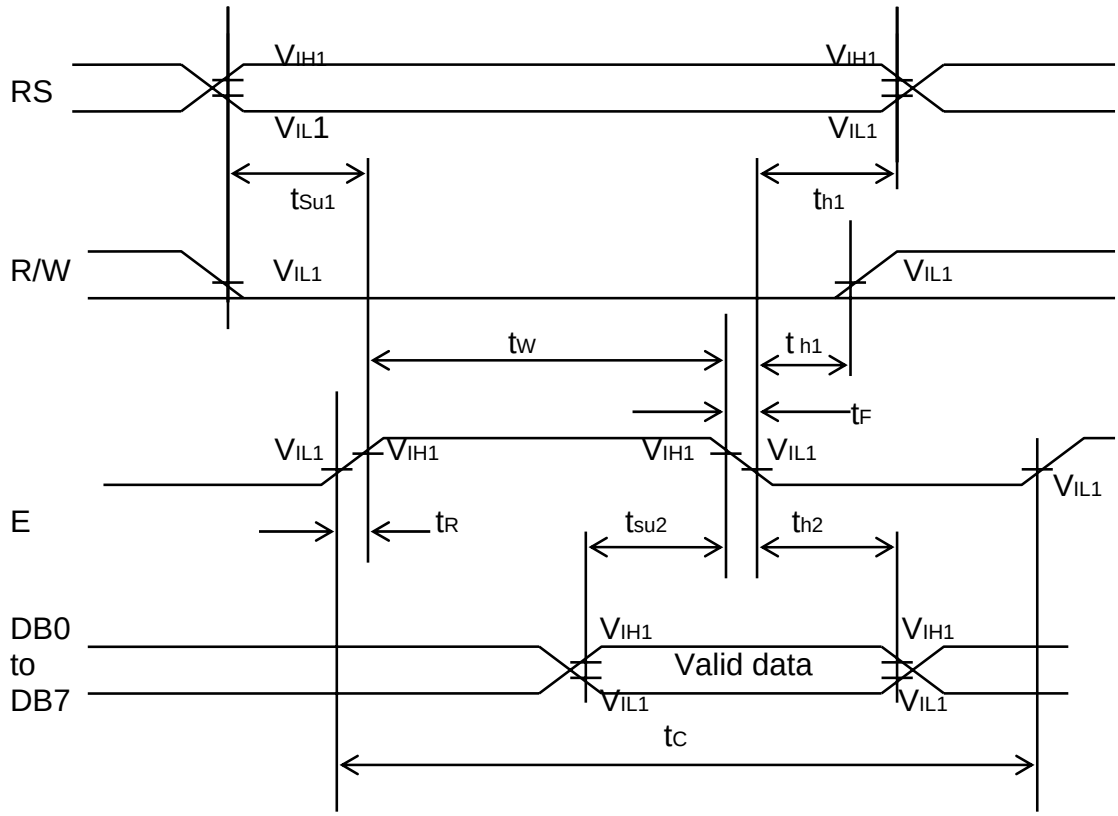
	Power source	Jumper setting	Mark
LED	VDD/VSS	J1,J3,R9	
	15K/16A	J2,J5,J7	
	A/K	NONE	
	15A/16K	J2,J4,J6	V
GND	BZL GND	J8	V
	FRM GND	J9	

7. TIMING CHARACTERISTICS

7.1 WRITE TIMING

AC characteristics (VDD=4.5v~5.5v,Ta=-30~85℃)

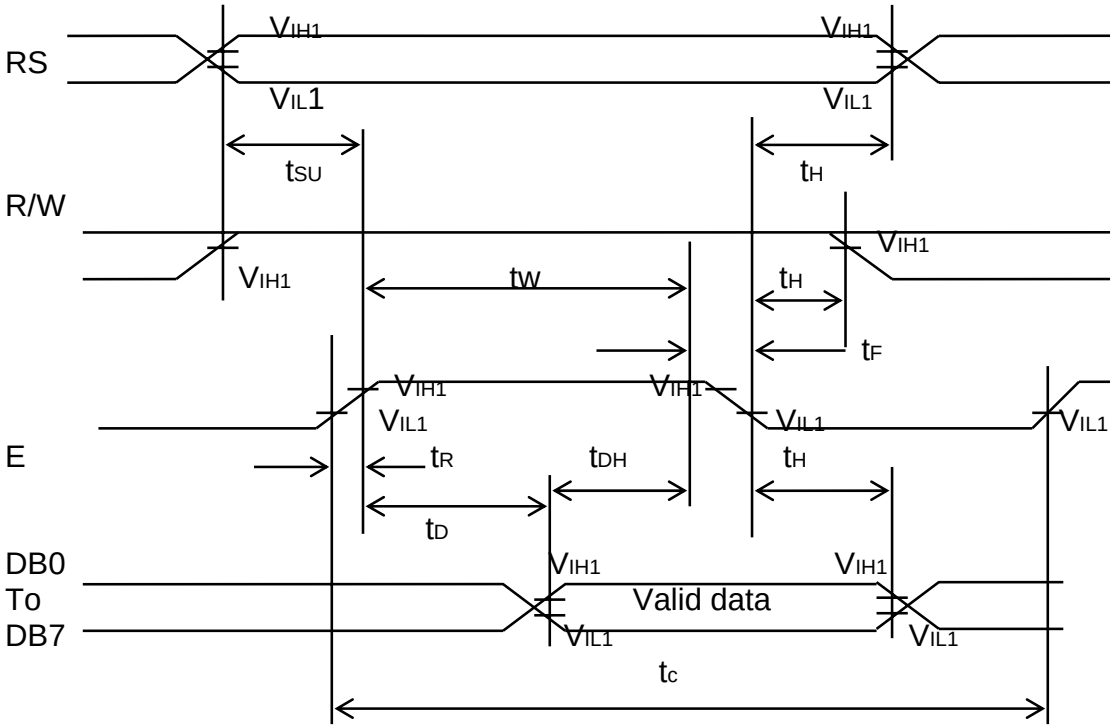
Item	Symbol	Condition	Min.	Max.	Unit
E cycle time	tcycE	VDD = 5V	500	--	ns
E pulse width (high level)	tWEH		300	--	
E rise/fall time	tER, tEF		--	20	
Address set-up time(RS,R/W,to E)	tAS		60[1] / 100[2]	--	
Address hold time	Tah		10	--	
Data set-up time	tDSW		100	--	
Data hold time	tH2		10	--	



7.2 READ TIMING

AC characteristics (VDD=4.5v~5.5v,Ta=-30~85°℃)

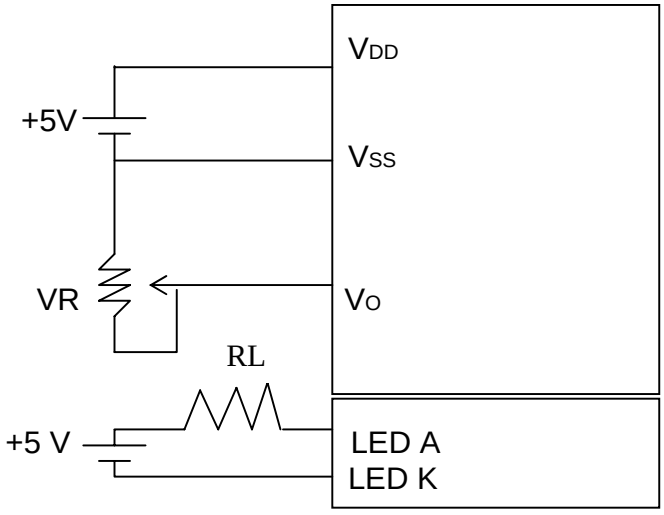
Item	Symbol	Condition	Min.	Max.	Unit
E cycle time	tcycE	VDD = 5V	500	--	ns
E pulse width (high level)	tWEH		300	--	
E rise/fall time	tER, tEF		--	25	
Address set-up time(RS,R/W,to E)	tAS		60[1] 100[2]	--	
Address hold time	Tah		10	--	
Data set-up time	tDSW		100	--	
Data hold time	tH2		10	--	



8. PIN CONNECTIONS

No.	Symbol	Function
1	VSS	Ground, 0V
2	VDD	Logic power supply, +5V
3	VO	Voltage for LCD drive
4	RS	Data / Instruction register select
5	R/W	Read / Write
6	E	Enable signal, start data read/write
7	DB0	Data Bus Line
8	DB1	
9	DB2	
10	DB3	
11	DB4	
12	DB5	
13	DB6	
14	DB7	
15	LED A	LED Anode, power supply +
16	LED K	LED Cathode, ground 0V

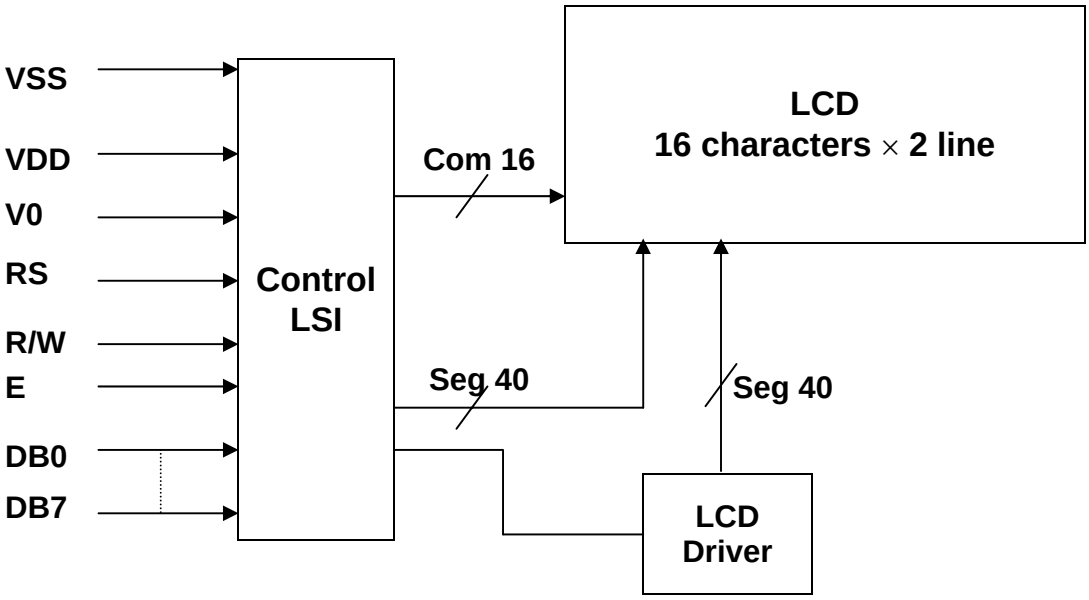
9. POWER SUPPLY



VR = 10K

RL: External current limit resistor.

10. BLOCK DIAGRAM



10.1 INSTRUCTIONS

Instruction	CODE										DESCRIPTION	Executed Time(max) focs=250KHz
	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
Clear Display	0	0	0	0	0	0	0	0	0	1	Clear all display and returns the cursor to the home position (Address 0)	1.64mS
Cursor At Home	0	0	0	0	0	0	0	0	1	*	Returns the cursor to the home position (Address 0). Also returns the display being shifted to the original position DDRAM contents remain unchanged	1.64mS
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	S	Sets the cursor move direction and specifies or not to shift the display. These operations are performed during data write and read.	40µS
Display On/Off Control	0	0	0	0	0	0	1	D	C	B	Sets the ON/OFF of all display (D) cursor ON/OFF (C), and blink of cursor position character (B)	40µS
Cursor/Display Shift	0	0	0	0	0	1	S/C	R/L	*	*	Moves the cursor and shifts the display without changing DDRAM contents	40µS
Function Set	0	0	0	0	1	DL	N	F	*	*	Sets interface data length (DL), number of display lines(N) and character font (F).	40µS
CGRAM Address Set	0	0	0	1	A_{CG}						Sets the CGRAM, data is sent and received after this setting.	40µS
DDRAM Address Set	0	0	1	A_{DD}							Sets the CGRAM, data is sent and received after this setting.	40µS
Busy Flag/ Address Read	0	1	BF	AC							Reads Busy flag (BF) indicating internal operation is being performed and reads address counter contents.	0µS
CGRAM/DDRAM Data Write	1	0	W_{RITE} D_{ATA}								Writes data into DDRAM or CGRAM	40µS
CGRAM/DDRAM Data Read	1	1	R_{EAD} D_{ATA}								Reads data into DDRAM or CGRAM	40µS

Code		Description		Executed Time (max.)
I/D=1: Increment	N=1:2Iines, N=0: 1 line	DDRAM:	Display Data RAM	Fcp or fosc = 250kHz
I/D=0: Decrement	1/16 duty	CGRAM:	Character Generator RAM	However, when frequency changes,
S=1: With display shift	1/8 duty, 1/11 duty	ACG:	CGRAM Address	execution time also changes
S/C=1: Display shift	F= 1: 5x10 dots	ADD:	DDRAM Address	
S/C=0: Cursor movement	F=0: 5x7 dots		Corresponds to cursor address	Example
R/L=1: Shift to the right	BF=1: Internal Operation is being performed	AC:	Address Counter, used for both	If fcp or fosc is 270kHz
R/L=0: Shift to the left	BF=0: Instruction acceptable		DDRAM and CGRAM	40µS x 250 = 37µS
DL=1 : 8-bit ,DL = 0:4-bit		c :	Invalid	270

Note:— indicates no effect.

c After execution of the CGRAM/DDRAM data write or read instruction, the RAM address counter is incremented or decremented by 1. The RAM address counter is updated after the busy flag turns off. In Figure 1, t_{ADD} is the time elapsed after the busy flag turns off until the address counter is updated.

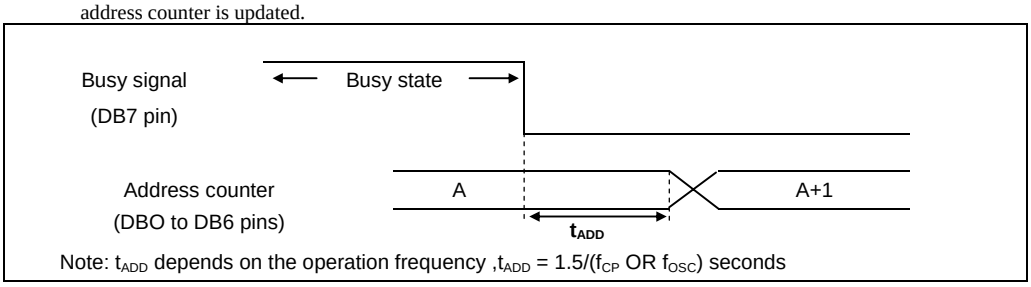


Figure 1 Address Counter Update

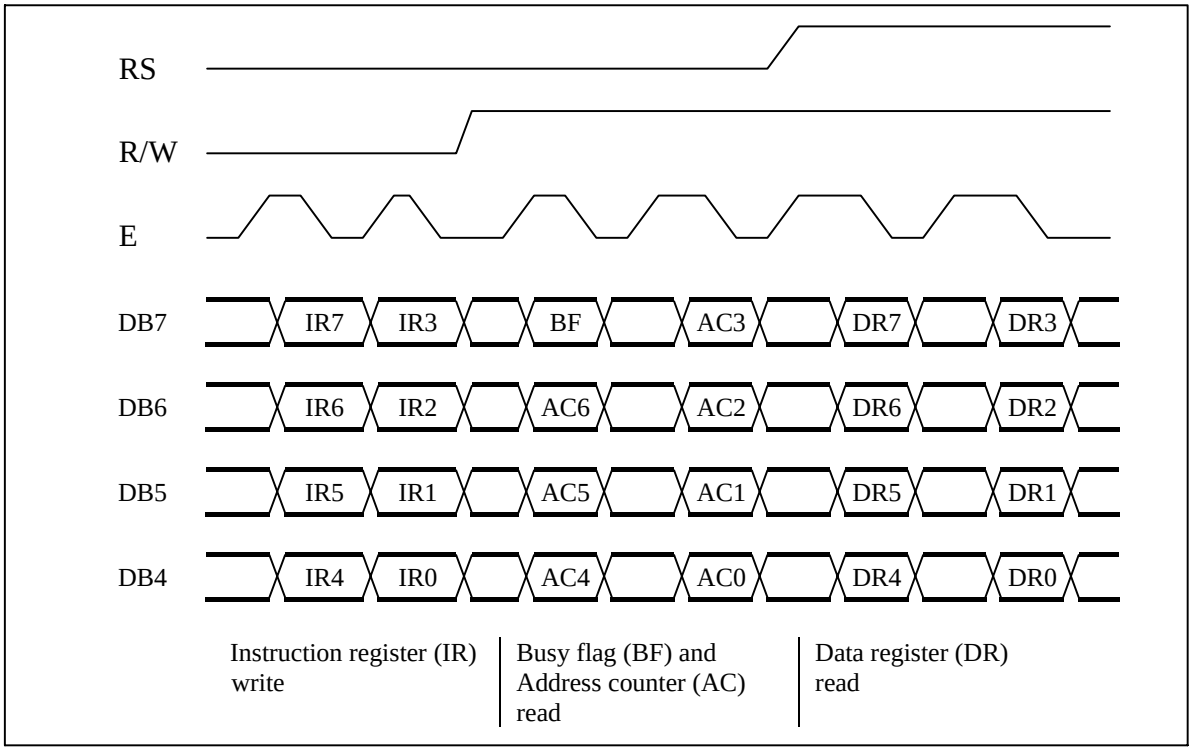
10.2 8-Bit Operation,8-Digit×2-Line Display Example

Step	Instruction											
No	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Display	Operation
1	Power supply on (the IC is initialized by the Internal reset circuit)											Initialized. No display.
2	Function set											Sets to 8-bit operation and selects 2-line display and 5×8 dot character font.
	0	0	0	0	1	1	1	0	*	*		
3	Display on/off control											Turns on display and cursor. All display is in space mode because of initialization.
	0	0	0	0	0	0	1	1	1	0		
4	Entry mode set											Sets mode to increment the address by one and to shift the cursor to the right at the time of write to the DD/CGRAM. Display is not shifted.
	0	0	0	0	0	0	0	1	1	0		
5	Write data to CGRAM/DDRAM										H_	Writes H. DDRAM has already been selected by initialization when the power was turned on. The cursor is incremented by one and shifted to the right
	1	0	0	1	0	0	1	0	0	0		
6	⋮										⋮	
7	Write data to CGRAM/DDRAM										HITACHI_	Writes I.
	1	0	0	1	0	0	1	0	0	1		
8	Set DDRAM address										HITACHI	Sets DDRAM address so that The cursor is positioned at the Head of the second line.
	0	0	1	1	0	0	0	0	0	0	_	
9	Write data to CGRAM/DDRAM										HITACHI	Writes M.
	1	0	0	1	0	0	1	1	0	1	M_	
10	⋮										⋮	
11	Write data to CGRAM/DDRAM										HITACHI	Writes O.
	1	0	0	1	0	0	1	1	1	1	MICROCO_	
12	Entry mode set										HITACHI	Sets mode to shift display at the time of write.
	0	0	0	0	0	0	0	1	1	1	MICROCO_	
13	Write data to CGRAM/DDRAM										ITACHI	Writes M. Display is shifted to the left. The first and second lines both shift at the same time.
	1	0	0	1	0	0	1	1	0	1	ICROCOM_	
14	⋮										⋮	
15	Return home										HITACHI	Returns both display and cursor to the original position (address 0).
	0	0	0	0	0	0	0	0	1	0	MICROCOM	

10.3 Interfacing to the MPU

The IC can send data in either two 4-bit operations, thus allowing interfacing with 4- or 8-bit MPU.

- For 4-bit interface data, only four bus lines (DB4 to DB7) are used for transfer. Bus lines DB0 to DB3 are disabled. The data transfer between the IC and the MPU is completed after the 4-bit data has been transferred twice. As for the order of data transfer, the four high order bits (for 8-bit operation,DB4 to DB7) are transferred before the four low order bits (for 8-bit operation, DB0 to DB3).
  The busy flag must be checked (one instruction) after the 4-bit data has been transferred twice. Two more 4-bit operations then transfer the busy flag and address counter data.



4-Bit Transfer Example

10.4

1-Line Display

Display position	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
DDRAM Address (hexadecimal)	00	01	02	03	04	05	06	07	40	41	42	43	44	45	46	47

16×1–Line

2-Line Display

Display position	1	2	3	4	5	···8···	···16···	···20···	···24···	39	40
DDRAM Address (hexadecimal)	00	01	02	03	04	.....				26	27
	40	41	42	43	44	.....				66	67

8×2–Line
16×2–Line
20×2–Line
24×2–Line

4-Line Display

Display position	1	2	3	.....	15	16
DDRAM Address (hexadecimal)	00	01	02	.....	0E	0F
	40	41	42		4E	4F
	14	15	16		1E	1F
	54	55	56		5E	5F

16×4 Line

Display position	1	2	3	.....	19	20
DDRAM Address (hexadecimal)	00	01	02	.....	12	13
	40	41	42		52	53
	14	15	16		26	27
	54	55	56		66	67

20×4 Line

10.5 CGRAM

Relationship between CGRAM Addresses, Character Codes (DDRAM) and Patterns (CGRAM Data)

For 5×8 dot character patterns

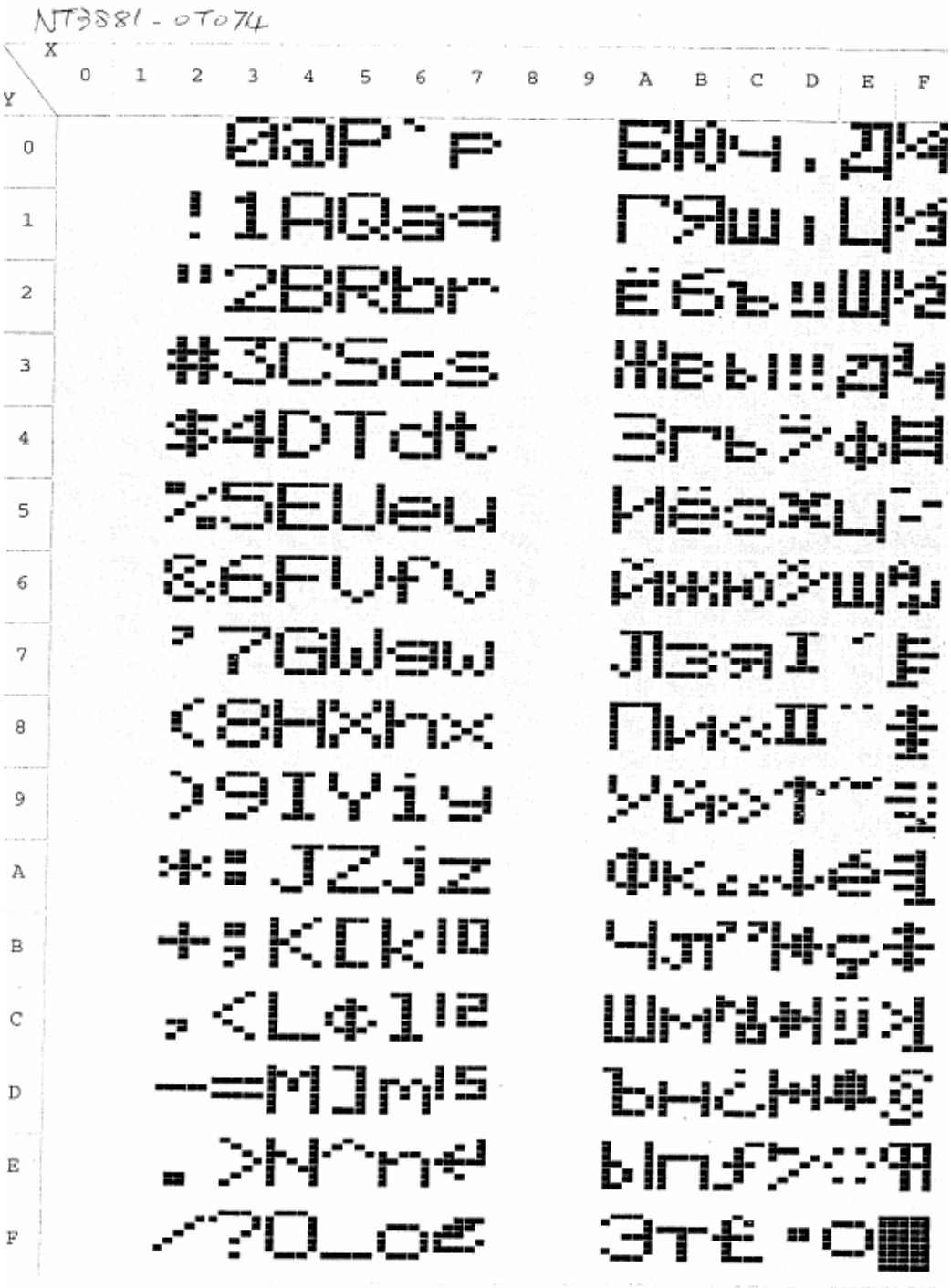
Character Codes (DDRAM data)	CGRAM Address	Character Patterns (CGRAM data)	
7 6 5 4 3 2 1 0 High Low	5 4 3 2 1 0 High Low	7 6 5 4 3 2 1 0 High Low	
0 0 0 0 ∗ 0 0 0	0 0 0	∗ ∗ ∗ 1 1 1 1 0 1 0 0 0 1 1 0 0 0 1 1 1 1 1 0 1 0 1 0 0 1 0 0 1 0 1 0 0 0 1 ∗ ∗ ∗ 0 0 0 0 0	Character Pattern (1) Cursor position
0 0 0 0 ∗ 0 0 1	0 0 1	∗ ∗ ∗ 1 0 0 0 1 0 1 0 1 0 1 1 1 1 1 0 0 1 0 0 1 1 1 1 1 0 0 1 0 0 0 0 1 0 0 ∗ ∗ ∗ 0 0 0 0 0	Character Pattern (2) Cursor position
	0 0 0 0 0 1	∗ ∗ ∗	
0 0 0 0 ∗ 1 1 1	1 1 1 1 0 0 1 0 1 1 1 0 1 1 1	∗ ∗ ∗	

Notes :

1. **Character code bits 0 to 2 correspond to CGRAM address bits 3 to 5 (3 bits: 8 types).**
2. **CGRAM address bits 0 to 2 designate the character pattern line position. The 8th line is the cursor position and its display is formed by a logical OR with the cursor. Maintain the 8th line data, corresponding to the cursor display position, at 0 as the cursor display.**
   If the 8th line data is 1, 1 bits will light up the 8th line regardless of the cursor presence.
3. **Character pattern row positions correspond to CGRAM data bits 0 to 4 (bit 4 being at the left).**
4. **As shown Table 5, CGRAM character patterns are selected when character code bits 4 to 7 are all 0. However, since character code bit 3 has no effect, the R display example above can be selected by either character code 00H or 08H.**
5. **1 for CGRAM data corresponds to display selection and 0 to non-selection.**

∗ **Indicates no effect.**

10.6 Correspondence between Character Codes and Character Patterns (ROM Code:00)



11. QUALITY ASSURANCE

11.1 Test Condition

11.1.1 Temperature and Humidity(Ambient Temperature)
Temperature : 20 ± 5°C
Humidity : 65 ± 5%

11.1.2 Operation
Unless specified otherwise, test will be conducted under function state.

11.1.3 Container
Unless specified otherwise, vibration test will be conducted to the product itself without putting it in a container.

11.1.4 Test Frequency
In case of related to deterioration such as shock test. It will be conducted only once.

11.1.5 Test Method

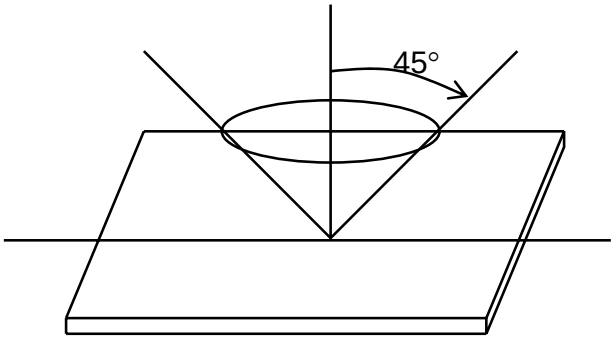
No.	Parameter	Conditions	Regulations
1	High Temperature Operating	70 ± 2 °C	Note 3
2	Low Temperature Operating	-20 ± 2 °C	Note 3
3	High Temperature Storage	80 ± 2 °C	Note 3
4	Low Temperature Storage	-30 ± 2 °C	Note 3
5	Vibration Test (Non-operation state)	Total fixed amplitude : 1.5mm Vibration Frequency : 10 ~ 55Hz One cycle 60 seconds to 3 directions of X.Y.Z. for each 15 minutes	Note 3
6	Damp Proof Test (Non-operation state)	40°C ± 2°C, 90~95%RH, 96h	Note 1,2
7	Shock Test (Non-operation state)	To be measured after dropping from 60cm high once concrete surface in packing state	Note 3

Note 1: Returned under normal temperature and humidity for 4 hrs.
Note 2: No dew condensation to be observed.
Note 3: No change on display and in operation under the test condition

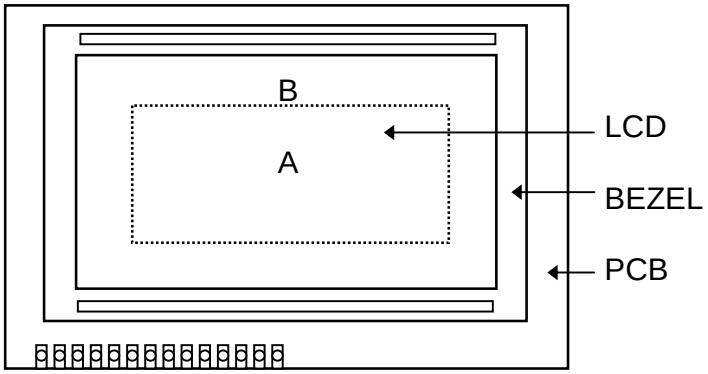
11.2 Inspection condition

11.2.1 Inspection conditions

The LCD shall be inspected under 40W white fluorescent light.

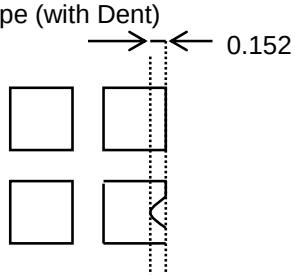


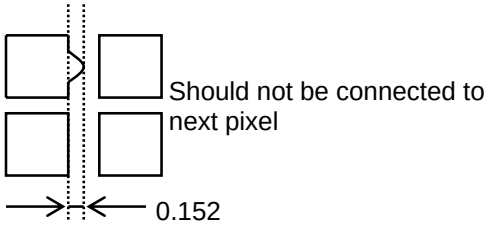
11.2.2 Definition of applicable Zones

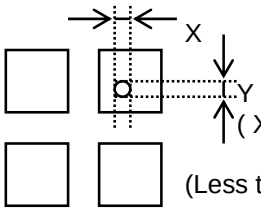


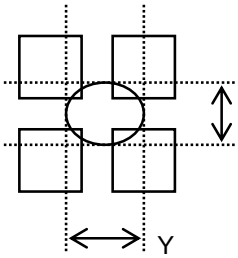
A : Display Area
B : Non-Display Area

11.2.3 Inspection Parameters

<table>
<tr><th>No.</th><th>Parameter</th><th>Criteria</th></tr>
<tr><td>1</td><td>Black or White spots</td><td>
<table>
<tr><th rowspan="2">Zone / Dimension</th><th colspan="2">Acceptable number</th><th rowspan="2">Class Of Defects</th><th rowspan="2">AQL Level</th></tr>
<tr><th>A</th><th>B</th></tr>
<tr><td>D < 0.15</td><td>*</td><td>*</td><td rowspan="4">Minor</td><td rowspan="4">2.5</td></tr>
<tr><td>0.15≤ D< 0.2</td><td>4</td><td>4</td></tr>
<tr><td>0.2 ≤ D ≤ 0.25</td><td>2</td><td>2</td></tr>
<tr><td>D ≤ 0.3</td><td>0</td><td>1</td></tr>
</table>
D = (Long + Short) / 2 * : Disregard
</td></tr>
<tr><td>2</td><td>Scratch, Substances</td><td>
<table>
<tr><th rowspan="2">Zone
X (mm) / Y(mm)</th><th colspan="2">Acceptable number</th><th rowspan="2">Class Of Defects</th><th rowspan="2">AQL Level</th></tr>
<tr><th>A</th><th>B</th></tr>
<tr><td>*</td><td>0.04 ≥ W</td><td>*</td><td>*</td><td rowspan="4">Minor</td><td rowspan="4">2.5</td></tr>
<tr><td>3.0 ≥ L</td><td>0.06 ≥ W</td><td>4</td><td>4</td></tr>
<tr><td>2.0 ≥ L</td><td>0.08 ≥ W</td><td>2</td><td>3</td></tr>
<tr><td>—</td><td>0.1 < W</td><td>0</td><td>1</td></tr>
</table>
X : Length Y : Width * : Disregard
Total defects should not exceed 4/module
</td></tr>
<tr><td>3</td><td>Air Bubbles
(between glass & polarizer)</td><td>
<table>
<tr><th rowspan="2">Zone / Dimension</th><th colspan="2">Acceptable number</th><th rowspan="2">Class of Defects</th><th rowspan="2">AQL Level</th></tr>
<tr><th>A</th><th>B</th></tr>
<tr><td>D ≤ 0.15</td><td>*</td><td>*</td><td rowspan="3">Minor</td><td rowspan="3">2.5</td></tr>
<tr><td>0.15 < D ≤ 0.25</td><td>2</td><td>*</td></tr>
<tr><td>0.25 < D</td><td>0</td><td>1</td></tr>
</table>
* : Disregard
Total defects shall not excess 3/module.
</td></tr>
<tr><td>4</td><td>Uniformity of Pixel</td><td>(1) Pixel shape (with Dent)
 
</td></tr>
</table>

<table>
<tr><td>4</td><td>Uniformity of Pixel</td><td colspan="2">(2) Pixel shape (with Projection)
 

(3) Pin hole
 

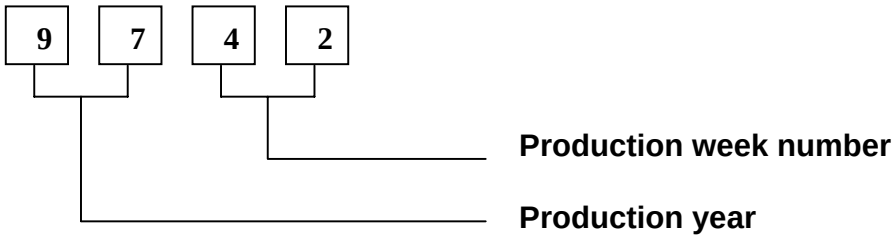
(X + Y)/2 ≤ 0.02mm
(Less than 0.1 mm is no counted)
(4) Deformation
 

X (X + Y) / 2 ≤ 0.3mm
Total acceptable number : 1/pixel, 5/cell</td></tr>
<tr><td rowspan="3">Class of defects</td><td rowspan="2">Major</td><td>AQL 0.65%</td><td>Definition</td></tr>
<tr><td>AQL 1.00%</td><td>It is a defect that is likely to result in failure or to reduce materially the usability of the product for the intended function.
It is a defect that is likely to assembly size and not result in functioning problem.</td></tr>
<tr><td>Minor</td><td>AQL 2.5%</td><td>It is a defect that will not result in functioning problem with deviation classified.</td></tr>
</table>

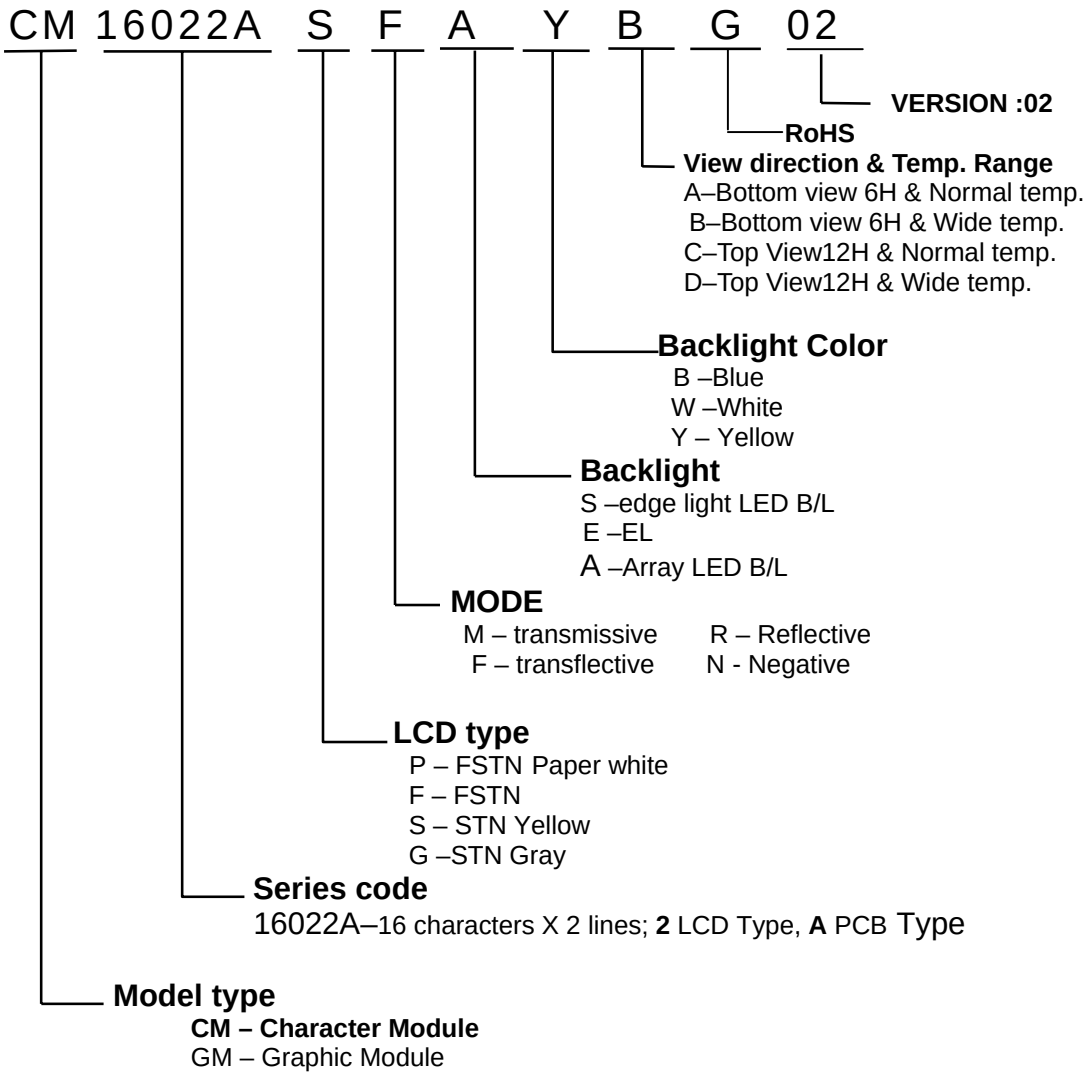
11.3 Sampling Condition

Unless otherwise agree in written, the sampling inspection shall be applied to the incoming inspection of customer.
Lot size: Quantity of shipment lot per model.
Sampling type: normal inspection, single sampling
Sampling table: MIL-STD-105E
Inspection level: Level II

12. LOT NUMBERING SYSTEM



13. LCM NUMBERING SYSTEM



14. PRECAUTION FOR USING LCM

1. LIQUID CRYSTAL DISPLAY (LCD)

LCD is made up of glass, organic sealant, organic fluid, and polymer based polarizers. The following precautions should be taken when handing,

(1). Keep the temperature within range of use and storage. Excessive temperature and humidity could cause polarization degredation, polarizer peel off or bubble.

(2). Do not contact the exposed polarizers with anything harder than an HB pencil lead. To clean dust off the display surface, wipe gently with cotton, chamois or other soft material soaked in petroleum benzin.

(3). Wipe off saliva or water drops immediately. Contact with water over a long period of time may cause polarizer deformation or color fading, while an active LCD with water condensation on its surface will cause corrosion of ITO electrodes.

(4). Glass can be easily chipped or cracked from rough handling, especially at corners and edges.

(5). Do not drive LCD with DC voltage.

2. Liquid Crystal Display Modules

2.1 Mechanical Considerations

LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modifications. The following should be noted.

(1). Do not tamper in any way with the tabs on the metal frame.

(2). Do not modify the PCB by drilling extra holes, changing its outline, moving its components or modifying its pattern.

(3). Do not touch the elastomer connector, especially insert an backlight panel (for example, EL).

(4). When mounting a LCM make sure that the PCB is not under any stress such as bending or twisting . Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.

(5). Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels.

2.2. Static Electricity

LCM contains CMOS LSI's and the same precaution for such devices should apply, namely

(1). The operator should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.

(2). The modules should be kept in antistatic bags or other containers resistant to static for storage.

(3). Only properly grounded soldering irons should be used.

(4). If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks.

(5) The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended.

(6). Since dry air is inductive to statics, a relative humidity of 50-60% is recommended.

2.3 Soldering

(1). Solder only to the I/O terminals.

(2). Use only soldering irons with proper grounding and no leakage.

(3). Soldering temperature : 280°C ± 10°C

(4). Soldering time: 3 to 4 sec.

(5). Use eutectic solder with resin flux fill.

(6). If flux is used, the LCD surface should be covered to avoid flux spatters. Flux residue should be removed after wards.

2.4 Operation

(1). The viewing angle can be adjusted by varying the LCD driving voltage V0.

(2). Driving voltage should be kept within specified range; excess voltage shortens display life.

(3). Response time increases with decrease in temperature.

(4). Display may turn black or dark blue at temperatures above its operational range; this is (however not pressing on the viewing area) may cause the segments to appear "fractured".

(5). Mechanical disturbance during operation (such as pressing on the viewing area) may cause the segments to appear "fractured".

2.5 Storage

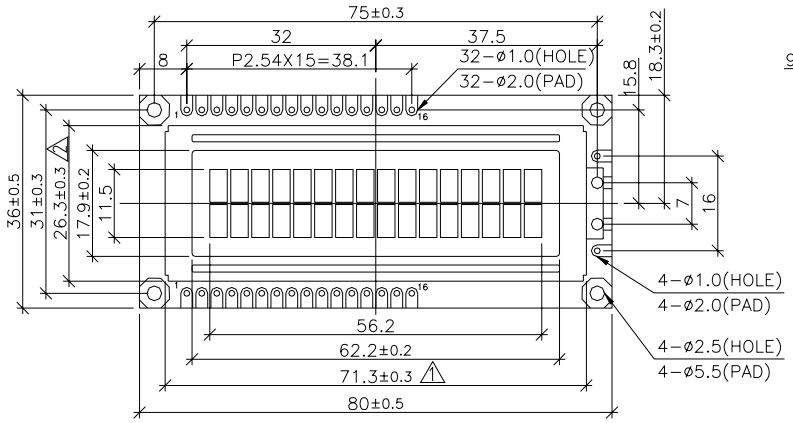
If any fluid leaks out of a damaged glass cell, wash off any human part that comes into contact with soap and water. Never swallow the fluid. The toxicity is extremely low but caution should be exercised at all the time.

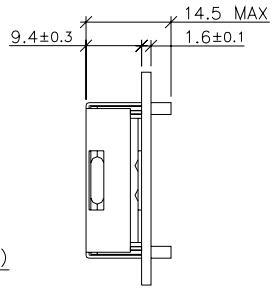
2.6 Limited Warranty

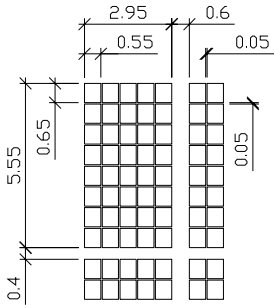
Unless otherwise agreed between DATA IMAGE and customer, DATA IMAGE will replace or repair any of its LCD and LCM which is found to be defective electrically and visually when inspected in accordance with DATA IMAGE acceptance standards, for a period on one year from date of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of DATA IMAGE is limited to repair and/or replacement on the terms set forth above. DATA IMAGE will not responsible for any subsequent or consequential events.

15. OUTLINE DRAWING

UNITS MM







Detail of Dots
Scale 5/1

PIN FUNCTIONS

1. VSS	9. DB2
2. VDD	10. DB3
3. V0	11. DB4
4. RS	12. DB5
5. R/W	13. DB6
6. E	14. DB7
7. DB0	15. LEDA
8. DB1	16. LEDK

Note: tolerance is ±0.3 unless otherwise noted.

2	Change dimension ,from 26.3$^{+0}_{-0.2}$ to 26.3±0.3	09/07/00	
1	Change dimension ,from 71.3$^{+0}_{-0.2}$ to 71.3±0.3	09/07/00	
AUTH	DESCRIPTION	DATE	APPROVED
REVISIONS			

ISSUE DATE:	08/04/98
DRAWN:	
CHECK:	
APPROVE:	

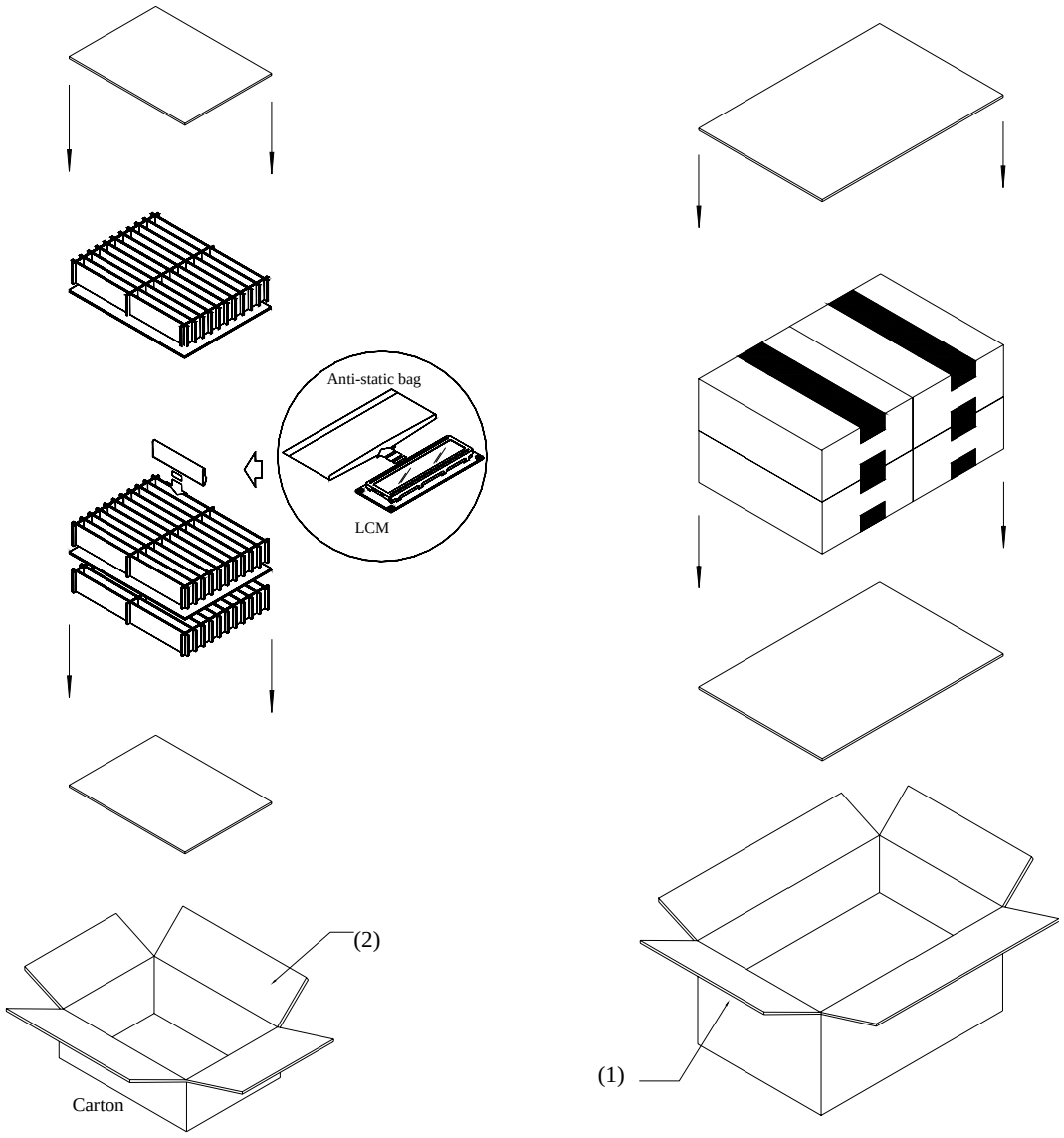
DATA IMAGE Corporation

TITLE: LCM OUTLINE DIMENSION

A4 | DWG. NO. Q970514 | PART. NO. CM1625L | REV. C

SCALE 1 / 1 | SHEET 1 OF 1

16. PACKAGE INFORMATION



Item	Size(L*W*H)	Quantity	Note
1.Master Carton	482*282*279	1	
2.Inner Carton	267*224*115	4	

Quantity Per Inner Carton	48	Quantity Per Master Carton	192
N . W	6.83 (kg)	G . W	9.61 (kg)